

REMARKS

This responds to the Office Action dated April 8, 2005, and the references cited therewith.

No claims are amended or canceled. Claims 7-13 and 20-25 remain pending in this application.

§102 Rejection of the Claims

Claims 7-9, 11, 12 and 20-25 were rejected under 35 U.S.C. § 102(b) as being anticipated by Buckley, III, et al. (U.S. Patent No. 5,477,082).

Claims 7-9 and 20-22

Applicant traverses the rejection of claims 7-9 and 20-22. "Anticipation requires the presence in a single prior reference disclosure of each and every element of the claimed invention, arranged as in the claim." *Lindemann Maschinenfabrik GmbH v. American Hoist & Derrick Co.*, 730 F.2d 1452, 221 USPQ 481, 485 (Fed. Cir. 1984). Applicant believes the cited reference does not include each and every element of the claimed invention, arranged as in the claim. For instance, Applicant cannot find in the cited reference an electrical component mounted on or above a surface of the IC chip and "electrically connected to the IC chip via a lead on the TAB leadframe which extends outward from the electrical component to a perimeter I/O of the IC chip." In contrast, Buckley discusses a double-sided structure where the devices 56, 58A are vertically aligned relative to each other and contacts 24A of a leadframe. (See Figs. 3 and 6 of Buckley). Accordingly, the cited reference does not include a lead on the TAB leadframe which extends outward from the electrical component to a perimeter I/O of the IC chip, as recited in claim 7.

Claims 8, 9, and 20-22 include each limitation of their parent claim and are therefore also not anticipated by the cited reference. Reconsideration and allowance is respectfully requested.

Claims 11, 12, and 23-25

Applicant traverses the rejection of claims 7-9 and 20-22. Applicant believes the cited reference does not include each and every element of the claimed invention, arranged as in the

claim. For instance, Applicant cannot find in the cited reference: wherein at least one of the plurality of leads is internally routed relative to the ILB area so that the at least one lead has a contact exposed interior to the ILB portion of the TAB structure and above a major surface of the IC chip; and an electrical component mounted on or above the major surface of the IC chip and electrically connected to the IC chip "via the at least one lead which has a contact exposed interior to the ILB portion of the TAB structure and above a major surface of the IC chip."

Again, Buckley discusses a double-sided structure where the devices 56, 58A are vertically aligned relative to each other and contacts 24A of a leadframe. (See Figs. 3 and 6 of Buckley). Accordingly, the cited reference does not include an electrical component mounted on or above the major surface of the IC chip and electrically connected to the IC chip via at least one lead which has a contact exposed interior to the ILB portion of the TAB structure and above a major surface of the IC chip, as recited in claim 11.

Claims 12 and 23-25 include each limitation of their parent claim and are therefore also not anticipated by the cited reference. Reconsideration and allowance is respectfully requested.

§103 Rejection of the Claims

Claims 10 and 13 were rejected under 35 U.S.C. § 103(a) as being unpatentable over Buckley, III, et al. (U.S. Patent No. 5,477,082) in view of admitted prior art (APA). Claims 10 and 13 include each limitation of their parent claims and are not obvious in view of the cited references for the reasons given above. Reconsideration and allowance is respectfully requested.

CONCLUSION

Applicant respectfully submits that the claims are in condition for allowance, and notification to that effect is earnestly requested. The Examiner is invited to telephone Applicant's attorney at (612) 359-3267 to facilitate prosecution of this application.

If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.


Respectfully submitted,

NICK A. YOUKER ET AL.

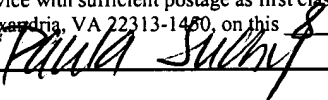
By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
P.O. Box 2938
Minneapolis, MN 55402
(612) 359-3267

Date 7/8/05

By 
Peter C. Maki
Reg. No. 42,832

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 8 day of July, 2005.


Name


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